

HSF



RoHS

DIM.A= 1.27 × No. of Spaces

DIM.B= DIM.A + 5.9

DIM.C= DIM.A + 1.69

DIM.D= DIM.A + 3.18

***Available in 4 ~ 26 Circuits**

SPECIFICATION

Current Rating: 1.0Amp
Insulation Resistance: 1000MΩ min
Contact Resistance: 20mΩ max
Withstand Voltage: 500V AC/DC
Operating Temperature: -40°C to +105°C
Contact Material: Brass
Contact Plating: Au or Sn Over Ni
Insulator Material: High Temperature plastic
 UL 94V-0

Ordering Code:

MFCR01 - **X** - **X** - **X** - **X** - **X**
 ① ② ③ ④ ⑤ ⑥

① **Series No:**

② **No. of Contacts**
 04P 06P 08P
 10P 12P 14P
 16P 18P 20P
 26P

③ **Insulator Material**
 A: PBT
 B: PA46
 C: SPECIAL

④ **Contact Plating**

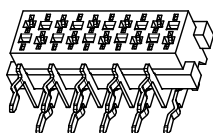
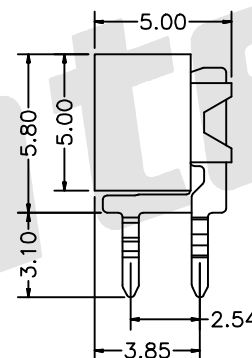
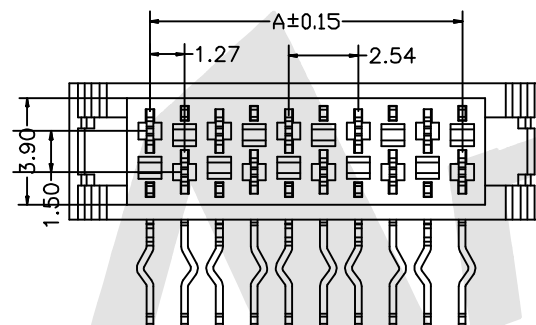
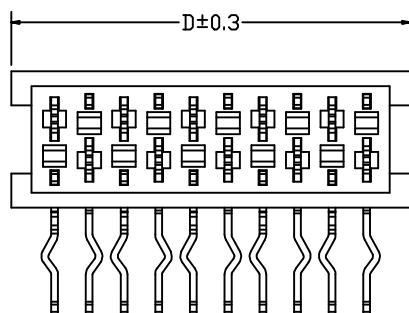
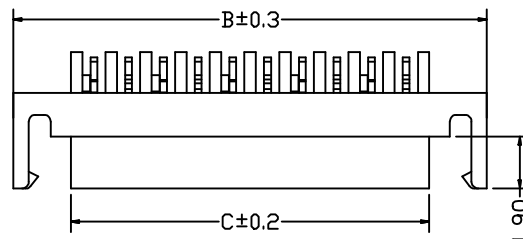
G0: Gold flash S0: Gold flash/Ni
 G1: 3u" Gold S1: 3u" Gold/Ni
 G2: 5u" Gold S2: 5u" Gold/Ni
 G3: 10u" Gold S3: 10u" Gold/Ni
 G4: 15u" Gold S4: 15u" Gold/Ni
 G5: 30u" Gold S5: 30u" Gold/Ni
 SN: Tin

⑤ **Packing**

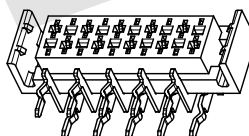
A: Tray B: Bag
 C: Tube D: Tape Reel

⑥ **Option**

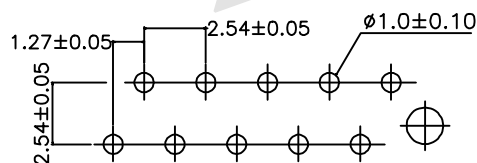
A: Type1 B: Type2



**W/O BUMP
Type1**



**WITH BUMP
Type2**



Recommended P.C. Board Layout

Unless Otherwise specified tolerance
 L ±0.35 L XX: ±0.30
 L I: ±0.25 L XXX: ±0.15

SCALE: As Shown UNIT: mm
 DRAW: Gong Feng DATE: 09/11/2017
 CHECK: Bob Yang DATE: 09/11/2017



Antenk ANTENK ELECTRONICS CO., LTD
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 E-mail: sales@antenk.com

TITLE:
 1.27mm Micro Match Socket 90° DIP

DRAWING NO: MFCR01-XXAXX

PRODUCT NO: MFCR01-XXAXX

REV

DESCRIPTION

DATE